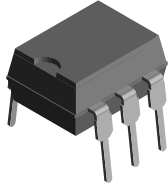
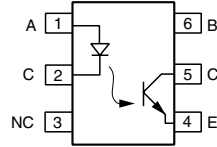


Optocoupler, Phototransistor Output, No Base Connection



1179009



DESCRIPTION

The MOC8111/ MOC8112 is an optocoupler consisting of a gallium arsenide infrared emitting diode optically coupled to a silicon planar phototransistor detector in a plastic plug-in DIP 6 pin package.

The coupling device is suitable for signal transmission between two electrically separated circuits. The potential difference between the circuits to be coupled should not exceed the maximum permissible reference voltages.

In contrast to the IL1, the base terminal is not connected, resulting in substantially improved common mode interference immunity.

FEATURES

- No base terminal connection for improved common mode interface immunity
- Long term stability
- Industry standard dual in line package
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC


RoHS
COMPLIANT

AGENCY APPROVALS

- UL1577, file no. E52744 system code H or J, double protection
- BSI IEC 60950; IEC 60065
- DIN EN 60747-5-2 (VDE 0884)/DIN EN 60747-5-5 pending available with option 1
- CSA 93751

ORDER INFORMATION

PART	REMARKS
MOC8111	CTR > 20 %, DIP-6
MOC8112	CTR > 50 %, DIP-6
MOC8111-X006	CTR > 20 %, DIP-6 400 mil (option 6)
MOC8111-X007	CTR > 20 %, SMD-6 (option 7)
MOC8112-X006	CTR > 50 %, DIP-6 400 mil (option 6)
MOC8112-X007	CTR > 50 %, SMD-6 (option 7)
MOC8112-X009	CTR > 50 %, SMD-6 (option 9)

Note

For additional information on the available options refer to option information.

ABSOLUTE MAXIMUM RATINGS (1)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
INPUT				
DC forward current		I_F	60	mA
Reverse voltage		V_R	6.0	V
Surge forward current	$t \leq 10 \mu\text{s}$	I_{FSM}	2.5	A
Total power dissipation		P_{diss}	100	mW
OUTPUT				
Emitter collector breakdown voltage		BV_{ECO}	30	V
Collector current		I_C	50	mA
	$t \leq 10 \mu\text{s}$	I_C	150	mA
Total power dissipation		P_{diss}	150	mW

ABSOLUTE MAXIMUM RATINGS ⁽¹⁾				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
COUPLER				
Isolation test voltage between emitter and detector refer to standard climate 23/50 DIN 50014		V_{ISO}	5300	V_{RMS}
Creepage distance			≥ 7	mm
Clearance distance			≥ 7	mm
Isolation thickness between emitter and detector			≥ 4	mm
Comparative tracking index per DIN IEC 112/VDE 0303, part 1		CTI	175	
Isolation resistance	$V_{IO} = 500 \text{ V}, T_{amb} = 25 \text{ }^\circ\text{C}$	R_{IO}	10^{12}	Ω
	$V_{IO} = 500 \text{ V}, T_{amb} = 100 \text{ }^\circ\text{C}$	R_{IO}	10^{11}	Ω
Storage temperature range		T_{stg}	- 55 to + 150	$^\circ\text{C}$
Ambient temperature range		T_{amb}	- 55 to + 100	$^\circ\text{C}$
Soldering temperature ⁽²⁾	max. 10 s, dip soldering distance to seating plane $\geq 1.5 \text{ mm}$	T_{slid}	260	$^\circ\text{C}$

Notes

⁽¹⁾ $T_{amb} = 25 \text{ }^\circ\text{C}$, unless otherwise specified.

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

⁽²⁾ Refer to reflow profile for soldering conditions for surface mounted devices (SMD). Refer to wave profile for soldering conditions for through hole devices (DIP).

ELECTRICAL CHARACTERISTICS						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT						
Forward voltage	$I_F = 10 \text{ mA}$	V_F		1.15	1.5	V
Reverse leakage current	$V_R = 6.0 \text{ V}$	I_R		0.05	10	μA
Junction capacitance	$V = 0 \text{ V}, f = 1.0 \text{ MHz}$	C_j		25		pF
OUTPUT						
Collector emitter breakdown voltage	$I_C = 1.0 \text{ }\mu\text{A}$	BV_{CEO}	30			V
Collector emitter leakage current	$V_{CE} = 10 \text{ V}$	I_{CEO}		1.0	50	nA
Emitter collector breakdown voltage	$I_E = 10 \text{ }\mu\text{A}$	BV_{ECO}	7.0			V
Collector emitter capacitance	$V_{CE} = 0 \text{ V}, f = 1.0 \text{ MHz}$	C_{CE}		7.0		pF
COUPLER						
Collector saturation voltage	$I_C = 500 \text{ }\mu\text{A}, I_F = 10 \text{ mA}$	V_{CEsat}		0.15	0.4	V

Note

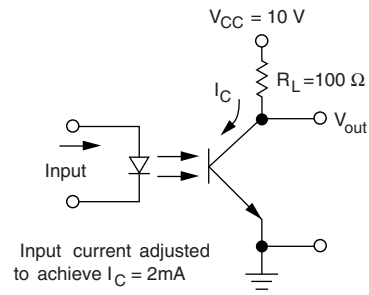
$T_{amb} = 25 \text{ }^\circ\text{C}$, unless otherwise specified.

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

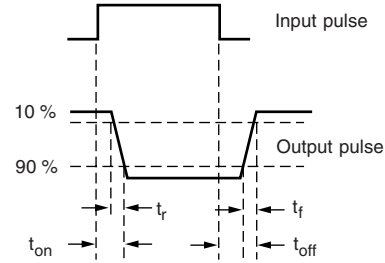
CURRENT TRANSFER RATIO							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Current transfer ratio	$I_F = 10 \text{ mA}, V_{CE} = 10 \text{ V}$	MOC8111	CTR	20			%
		MOC8112	CTR	50			%

SWITCHING CHARACTERISTICS						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Turn-on time	$V_{CC} = 10 \text{ V}, R_L = 100 \text{ }\Omega$ $I_C = 2.0 \text{ mA}$, see figure 1	t_{on}		7.5	20	μs
Turn-off time	$V_{CC} = 10 \text{ V}, R_L = 100 \text{ }\Omega$ $I_C = 2.0 \text{ mA}$, see figure 1	t_{off}		5.7	20	μs

Optocoupler, Phototransistor Output, Vishay Semiconductors No Base Connection



Test Circuit

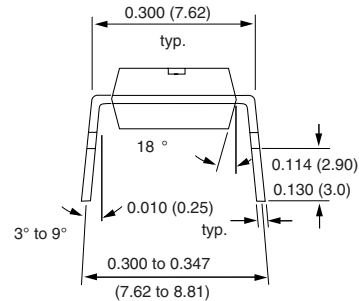
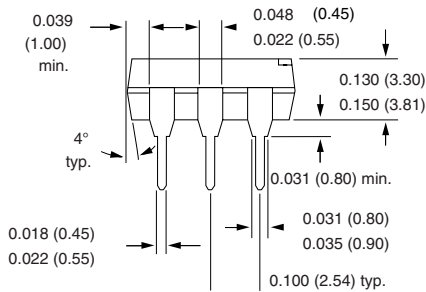
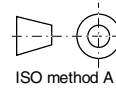
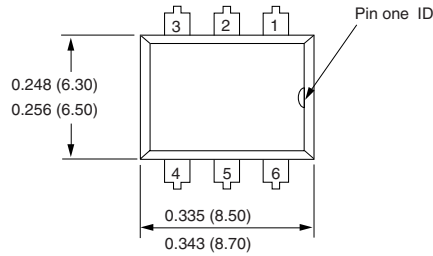


Waveforms

imoc8111_01

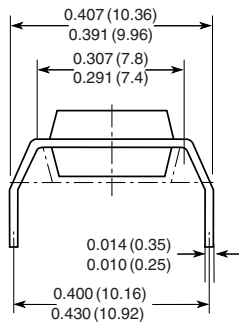
Fig. 1 - Switching Times

PACKAGE DIMENSIONS in inches (millimeters)

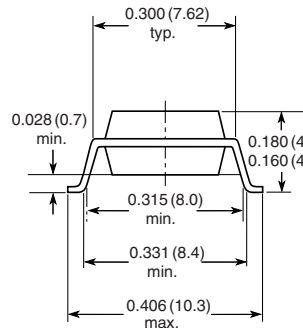


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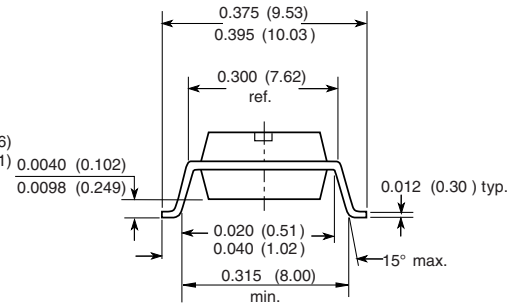
Option 6



Option 7



Option 9



18450



OZONE DEPLETING SUBSTANCES POLICY STATEMENT

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively.
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA.
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design
and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany



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